

14849 Firestone Boulevard • La Mirada, CA 90638
 Phone: (714) 670-SSDI (7734) • Fax: (714) 522-7424

Designer's Data Sheet

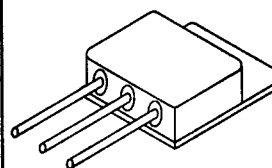
FEATURES:

- Rugged construction with polysilicon gate
- Low RDS(on) and high transconductance
- Excellent high temperature stability
- Very fast switching speed
- Fast recovery and superior dv/dt performance
- Increased reverse energy capability
- Low input and transfer capacitance for easy paralleling
- Ceramic Seals for improved hermeticity
- Hermetically sealed surface mount power package
- TX, TXV and Space Level screening available
- Replaces: IXTH10N100 Types

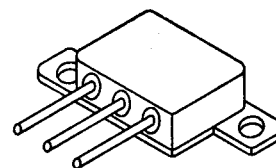
SFF10N100N
SFF10N100P

10 AMP
1000 VOLTS
1.2 Ω
N-CHANNEL
POWER MOSFET

TO-258



TO-259



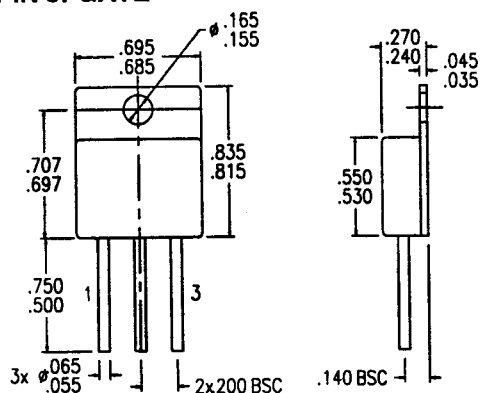
MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	VALUE	UNIT
Drain to Source Voltage	V _{DS}	1000	Volts
Gate to Source Voltage	V _{GS}	±20	Volts
Continuous Drain Current	I _D	10	Amps
Operating and Storage Temperature	T _{op} & T _{stg}	-55 to +150	°C
Thermal Resistance, Junction to Case	R _{θJC}	0.83	°C/W
Total Device Dissipation @ TC=25°C	P _D	150	Watts
Total Device Dissipation @ TC=55°C		114	

PACKAGE OUTLINE: TO-258 (N)

PIN OUT:

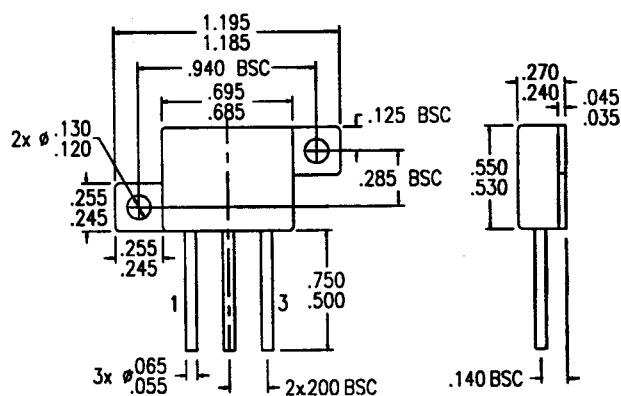
PIN 1: DRAIN
 PIN 2: SOURCE
 PIN 3: GATE



PACKAGE OUTLINE: TO-259 (P)

PIN OUT:

PIN 1: DRAIN
 PIN 2: SOURCE
 PIN 3: GATE



NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: F00181 B

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SFF10N100N
SFF10N100P
SOLID STATE DEVICES, INC

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ELECTRICAL CHARACTERISTICS @ $T_J=25^{\circ}\text{C}$ (Unless Otherwise Specified)

RATING		SYMBOL	MIN	TYP	MAX	UNIT
Drain to Source Breakdown Voltage ($V_{GS}=0\text{ V}$, $I_D=3\text{mA}$)		BV_{DSS}	1000	---	---	V
Drain to Source on State Resistance ($V_{GS}=10\text{ V}$, $I_D=50\%$ Rated ID)		$R_{DS(on)}$	---	1.05	1.2	Ω
On State Drain Current ($V_{DS}=15\text{V}$, $V_{GS}=10\text{ V}$)		$I_{D(on)}$	10	---	---	A
Gate Threshold Voltage ($V_{DS}\geq V_{GS}$, $I_D=4\text{mA}$)		$V_{GS(th)}$	2.0	---	4.5	V
Forward Transconductance ($V_{DS}>I_{D(on)} \times R_{DS(on)}$ Max, $I_{DS}=50\%$ rated ID)		g_{fs}	5	8	---	S(Ω)
Zero Gate Voltage Drain Current ($V_{DS}=\text{max rated voltage}$, $V_{GS}=0\text{ V}$) ($V_{DS}=80\%$ rated VDS, $V_{GS}=0\text{ V}$, $T_A=125^{\circ}\text{C}$)		I_{DSS}	---	---	250 1000	μA
Gate to Source Leakage Forward Gate to Source Leakage Reverse	At rated VGS	I_{GSS}	---	---	+100 -100	nA
Total Gate Charge Gate to Source Charge Gate to Drain Charge	$V_{GS}=10\text{ Volts}$ 50% rated VDS Rated ID	Q_g Q_{gs} Q_{gd}	---	110 20 40	155 45 80	nC
Turn on Delay Time Rise Time Turn Off Delay Time Fall Time	$V_{DD}=50\%$ rated VDS 50% rated ID $R_G=6.2\Omega$ $V_{GS}=10\text{V}$	$t_{d(on)}$ t_r $t_{d(off)}$ t_f	---	30 20 110 40	50 50 130 50	nsec
Diode Forward Voltage ($I_S=\text{rated ID}$, $V_{GS}=0\text{ V}$, $T_J=25^{\circ}\text{C}$)		V_{SD}	---	---	1.5	V
Diode Reverse Recovery Time Reverse Recovery Charge	$T_J=25^{\circ}\text{C}$ $I_F=\text{rated ID}$ $di/dt=100\text{ A}/\mu\text{sec}$	t_{rr} Q_{RR}	---	850 ---	1200 ---	nsec μC
Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{GS}=0\text{ Volts}$ $V_{DS}=25\text{ Volts}$ $f=1\text{ MHz}$	C_{iss} C_{oss} C_{rss}	---	4000 310 70	---	pF

For thermal derating curves and other characteristic curves please contact SSDI Marketing Department.